Diplete - ET (OLD SCHEME)

Code: DE06 **Time: 3 Hours**

DECEMBER 2010

Subject: BASIC ELECTRONICS

Max. Marks: 100

NOTE:	There	are 9	Ouestions	in	all
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in • The ho • Ou qu	the se and our of the office o	space provided for it in the answ swer sheet for the Q.1 will be of the commencement of the exan the remaining EIGHT Question on carries 16 marks.	O marks. Answer to Q.1 must be written ver book supplied and nowhere else. collected by the invigilator after half an nination. Ons answer any FIVE Questions. Each may be suitably assumed and stated.			
Q.1		Choose the correct or best alternative in the following: (2x10				
	a.	Which of the following components is used to couple alternating voltage from one circuit to another circuit?				
		(A) Capacitor(C) Resistor	(B) Inductor(D) Diode.			
	b.	For electron emission, which of t	the following is employed?			
		(A) Semiconductors(C) Metals	(B) Insulators(D) None of these			
	c.	The IC package that is most wide	ely used is.			
		(A) Plastic DIL package(C) Ceramic package	(B) Metal can package(D) None			
	d.	d. Voltage gain of a practical op-amp is of the order of				
		(A) 10 ² (C) 1	(B) 10 (D) 10 ⁵			
	e	If the differential and common-mode gains of a differential amplifier are 100 and 0.4 respectively, then the CMRR will be				
		(A) 10. (C) 94.5.	(B) 25. (D) 250.			
	f.	. Voltage follower is a special case of				
		(A) inverting amplifier(C) differential amplifier	(B) non-inverting amplifier(D) can be any of these			
g		The minimum on-state current required to keep the SCR in conducting state without any gate drive is called.				
		(A) holding current(C) surge current	(B) on-state current(D) latching current			
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	h.	In the pinch-off region, FET behaves as a				
		(A) constant voltage source(C) constant current source	(B) ordinary resistor(D) diode			
	i.	Which transistor configuration is used for impedance matching?				
		(A) CC (C) CB	(B) CE(D) all of these			
	j.	Which of the following property is true for an ordinary transistor?				
		(A) It is bipolar(C) It is a voltage controlled device	(B) Base is heavily doped(D) None of these			
	Answer any FIVE Questions out of EIGHT Questions. Each question carries 16 marks.					
Q.2	a.	State and explain the Thevenin's theorem and Thevenin's equivalent circuit. (10)				
	b.	What do you understand by an ideal a practical voltage source is conside	voltage source? Under what condition red to be a good voltage source?	1, (6)		
Q.3	a.	Distinguish between the following (i) Intrinsic and Extrinsic Semicon (ii) Drift and Diffusion current.	luctor.	(8)		
	b.	Explain zener and avalanche breakd	own in semiconductors	(8)		
Q.4	a.	Explain the working of a half-wave (i) DC current (ii) RMS current (iii) Ripple factor (iv) Efficiency.	rectifier and derive the values of	(4)(3)(3)(3)(3)		
Q.5	a.	Define α and β of a transistor. Also	derive the relationship between them.	(8)		
	b.	Why CE configuration of transisto Also give reason why CC configura	r is mostly used in amplifier circuits ion is seldom used?	? (4)		
	c.	A transistor has α_{dc} of 0.98 and Calculate the collector and the base $% \left(1,0,0,0,0,0,0,0,0,0,0,0,0,0,0,0,0,0,0,0$	collector leakage current I_{co} of $1\mu A$ current when $I_E = 1mA$.	. (4)		
Q.6	a.	Explain the basic structure and work	ing of a p-channel JFET.	(10)		
	b.	How does a MOSFET differ from J	FET?	(6)		

Q.7	a.	Explain the term 'work function' in connection with electron emission.	(6)
	b.	What is secondary emission? On what factors does the number of emitted electrons depend?	(4)
	c.	Write a short note on LCD & LED.	(6)
Q.8	a.	An inverting op-amp has $R_f=100k\Omega$ and $R_1=2~k\Omega$. Find the voltage gain of the amplifier. Also find the amplifier input resistance, input current and the output voltage if the input voltage is 0.1V. Assume op-amp to be ideal	[
	b.	Explain the working of an op-amp as an integrator circuit.	(8)
Q. 9.	a.	How are integrated circuits classified on the basis of the fabrication technique used?	(6)
	b.	What do you understand by 'photolithographic process'?	(6)
	c.	Explain the term 'substrate' as applicable to monolithic IC.	(4)